

2SJ518 Silicon P Channel MOS FET

REJ03G0875-0400 (Previous: ADE-208-580B) Rev.4.00 Sep 07, 2005

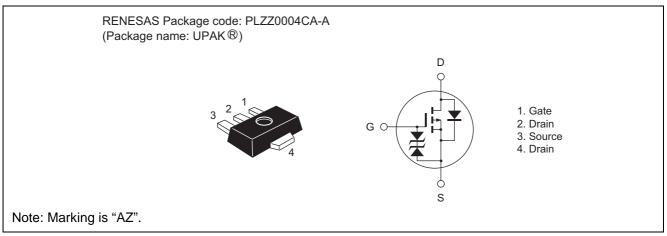
Description

High speed power switching

Features

- Low on-resistance $R_{DS\;(on)}=0.35\;\Omega\;typ.\;(at\;V_{GS}=-10\;V,\,I_D=-1\;A)$
- Low drive current
- 4 V gate drive devices
- High speed switching

Outline



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Absolute Maximum Ratings

			$(Ta = 25^{\circ}C)$
Item	Symbol	Value	Unit
Drain to source voltage	V _{DSS}	-60	V
Gate to source voltage	V _{GSS}	±20	V
Drain current	ID	-2	А
Drain peak current	I _{D (pulse)} Note 1	-4	А
Body to drain diode reverse drain current	I _{DR}	-2	А
Avalanche current	I _{AP} Note 2	-2	А
Avalanche energy	E _{AR}	0.34	mJ
Channel dissipation	Pch Note 3	1	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	℃

Notes: 1. PW \leq 10 $\mu s,\,duty\,cycle \leq$ 1%

2. Value at Tch = 25° C, Rg $\geq 50 \Omega$

3. Value at when using the aluminum ceramic board (12.5 \times 20 \times 0.7 mm)

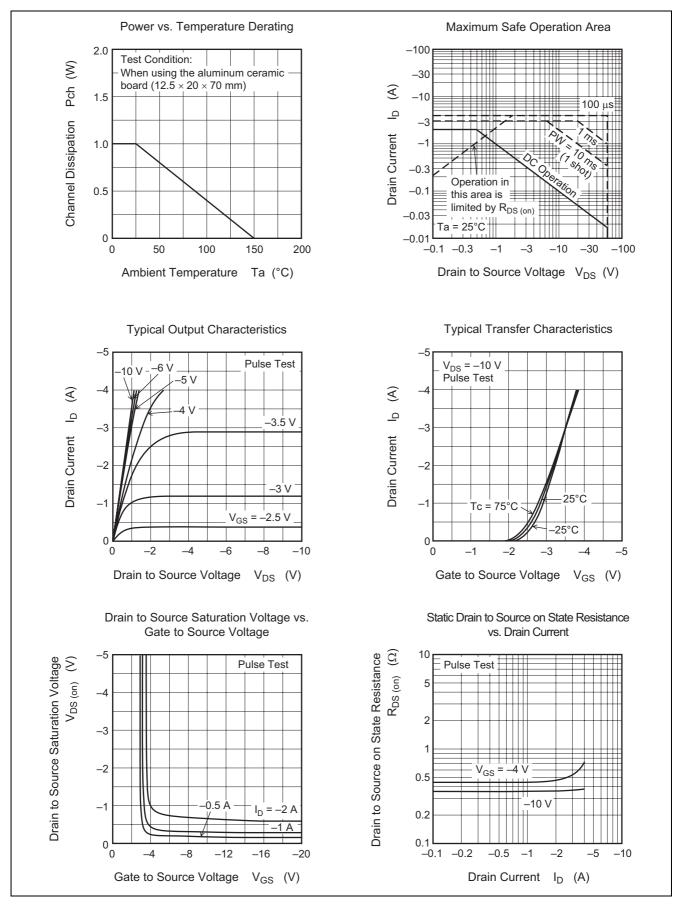
Electrical Characteristics

						$(Ta = 25^{\circ}C)$
ltem	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	V (BR) DSS	-60		_	V	$I_D = -10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	V (BR) GSS	±20	_	_	V	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	—		-10	μΑ	$V_{DS} = -60 \text{ V}, \text{ V}_{GS} = 0$
Gate to source leak current	I _{GSS}	—	_	±10	μΑ	$V_{GS} = \pm 16 V, V_{DS} = 0$
Gate to source cutoff voltage	V _{GS (off)}	-1.0	_	-2.0	V	$I_D = -1 \text{ mA}, V_{DS} = -10 \text{ V}$
Static drain to source on state resistance	R _{DS (on)}	—	0.35	0.46	Ω	$I_D = -1 \text{ A}, V_{GS} = -10 \text{ V}^{Note 4}$
	R _{DS (on)}	—	0.45	0.63	Ω	$I_D = -1 A, V_{GS} = -4 V^{Note 4}$
Forward transfer admittance	y _{fs}	1.2	2.0		S	$I_D = -1 \text{ A}, V_{DS} = -10 \text{ V}^{Note 4}$
Input capacitance	Ciss	—	220		pF	$V_{DS} = -10 V$
Output capacitance	Coss	—	110		pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	—	35		pF	f = 1 MHz
Turn-on delay time	t _{d (on)}	—	10		ns	$V_{GS} = -10 V$
Rise time	tr	—	11		ns	$I_D = -1 A$
Turn-off delay time	t _{d (off)}	_	45	_	ns	$R_L = 30 \Omega$
Fall time	t _f		30	—	ns	
Body to drain diode forward voltage	V _{DF}		-1.05	_	V	$I_F = -2 A, V_{GS} = 0$
Body to drain diode reverse recovery time	t _{rr}	_	50	_	ns	$I_F = -2 A, V_{GS} = 0$
						di _F /dt = 50 A/µs

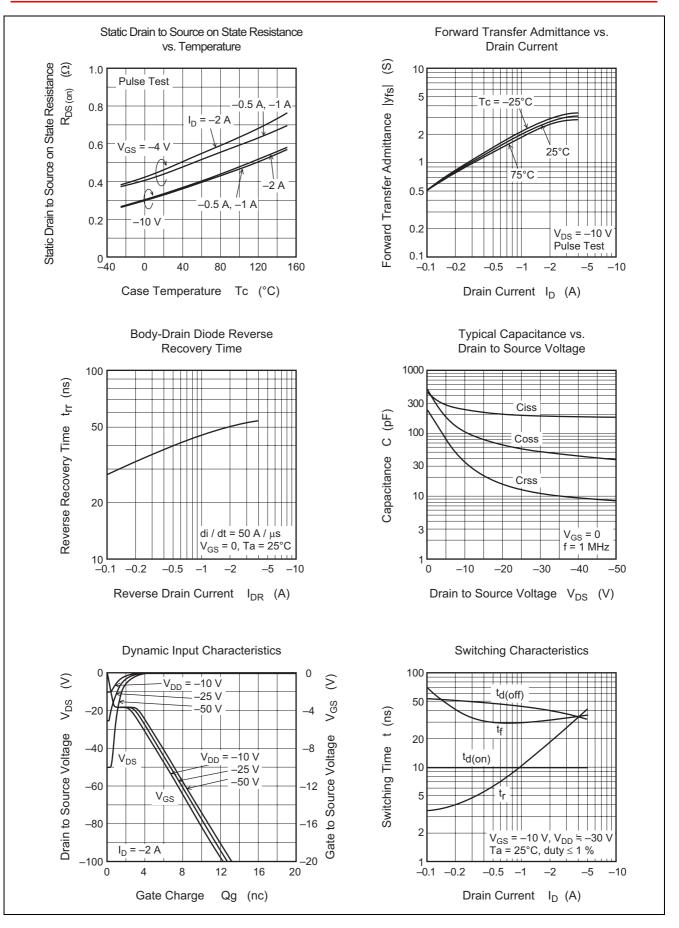
Note: 4. Pulse test



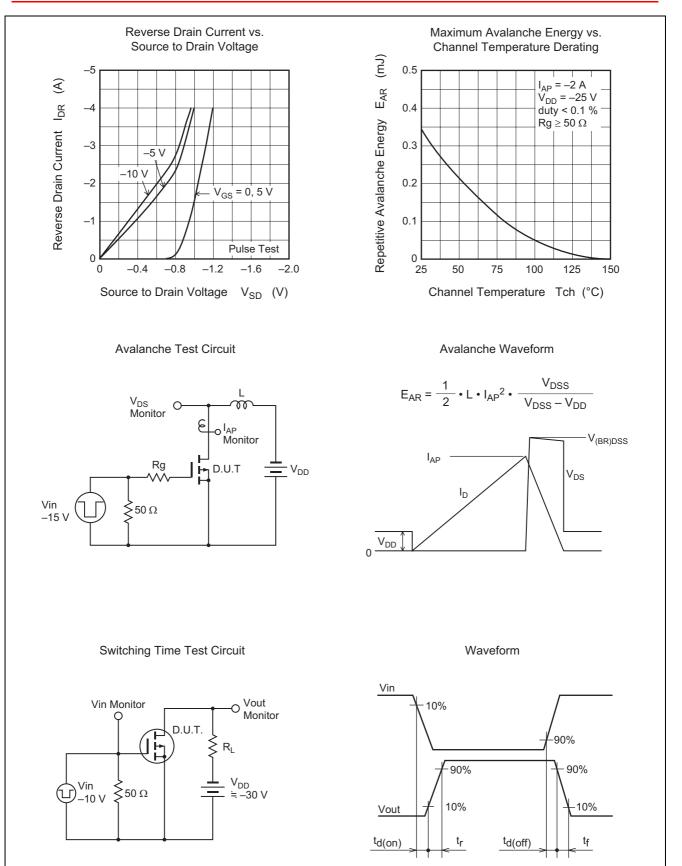
Main Characteristics





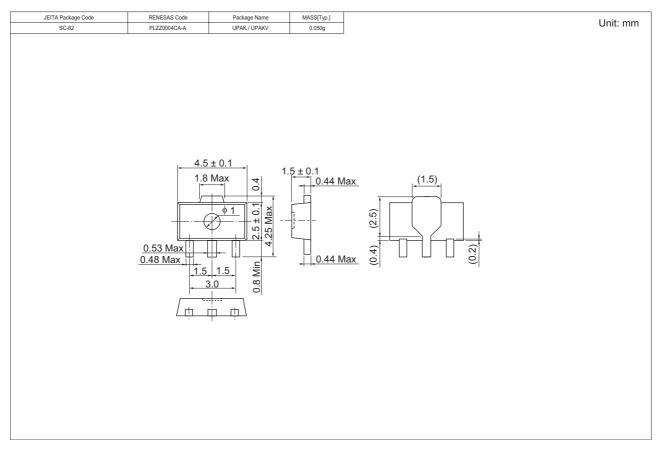








Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
2SJ518AZTL-E	1000 pcs	Taping
2SJ518AZTR-E	1000 pcs	Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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